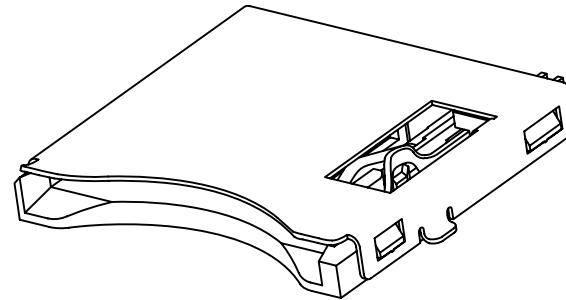
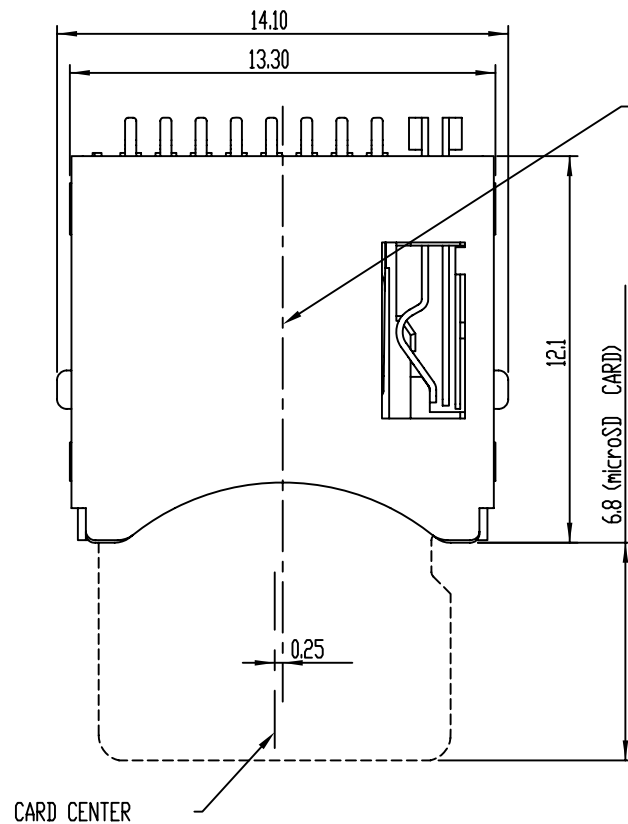


MATERIAL:
 INSULATOR: HIGH TEMPRATURE THERMOPLASTIC,
 UL94V-0,BLACK
 CONTACT: PHOSPHOR BRONZE

PLATING:
 CONTACT AREA PLATING: Gold 10u" OVER Ni
 SOLDER AREA : Tin Plated OVER 50u" Ni



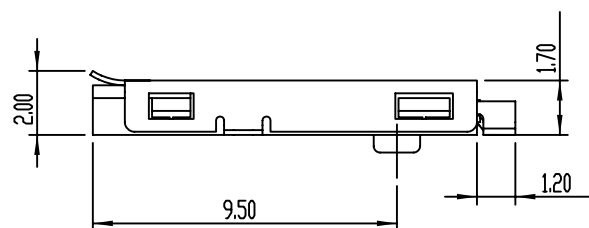
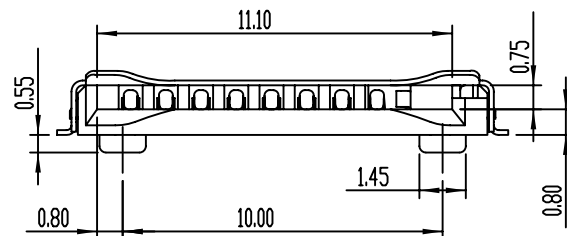
112I-T X A R-R
 1 2 3 4

1.Type
 T:Top Mount

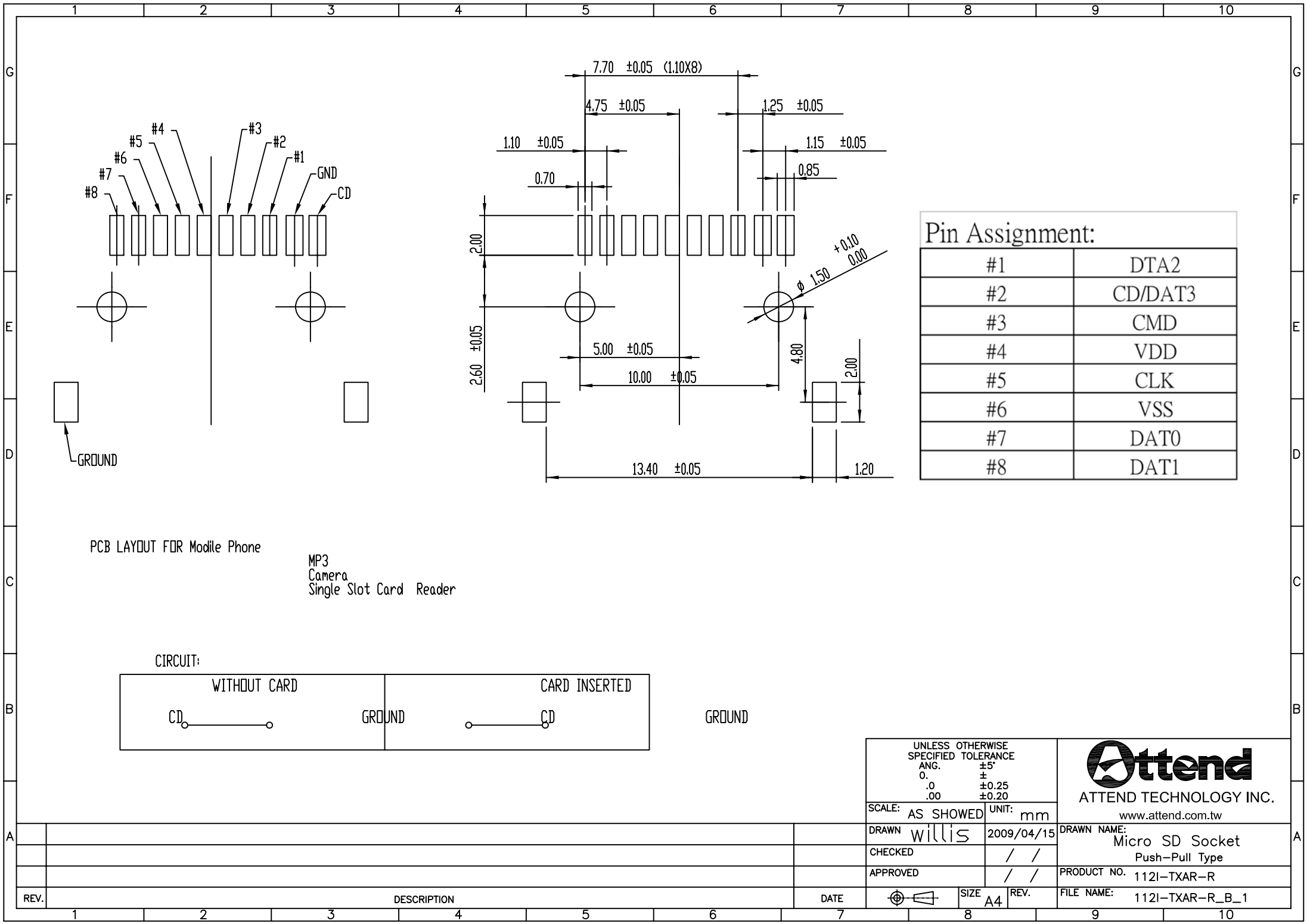
2.Contact Plating
 A:Gold Flash
 D:10u"Gold Plating

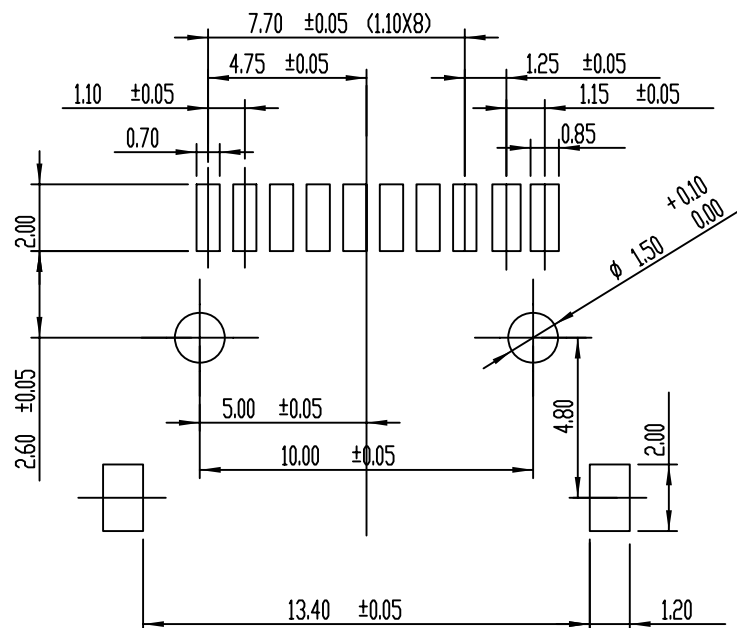
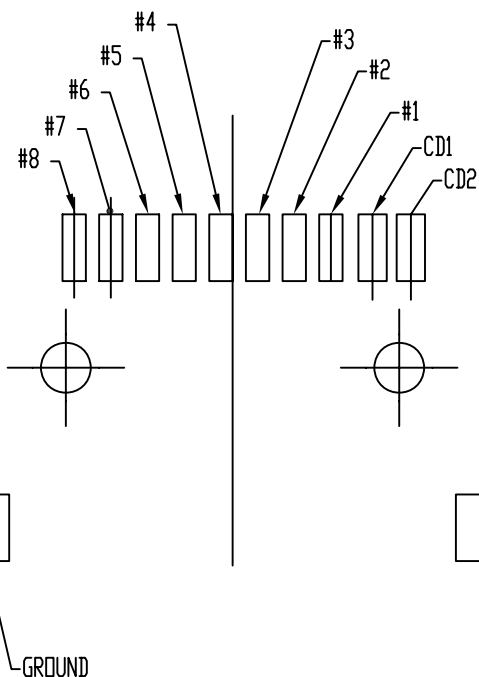
3.Stand Off
 A:0mm

4.RoHS



UNLESS OTHERWISE SPECIFIED TOLERANCE		Attend ATTEND TECHNOLOGY INC. www.attend.com.tw	
ANG.	±5°		
0.	±	SCALE: AS SHOWN UNIT: mm DRAWN willis 2009/04/15 CHECKED / / APPROVED / /	
.0	±0.25		
.00	±0.20	DRAWN NAME: Micro SD Socket Push-Pull Type PRODUCT NO. 112I-TXAR-R FILE NAME: 112I-TXAR-R_B_1	
REV.	DESCRIPTION	DATE	SIZE A4 REV.

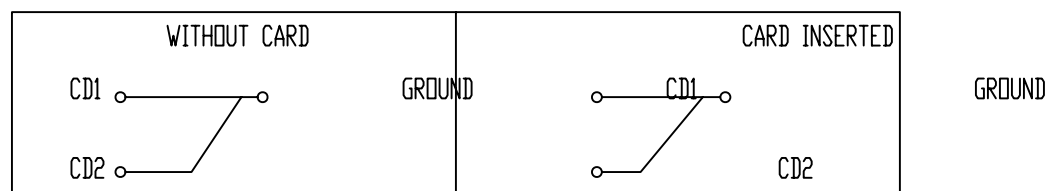




Pin Assignment:	
#1	DTA2
#2	CD/DAT3
#3	CMD
#4	VDD
#5	CLK
#6	VSS
#7	DAT0
#8	DAT1

PCB LAYOUT FOR Multi Slot Card Reader

CIRCUIT:



UNLESS OTHERWISE SPECIFIED TOLERANCE ANG. ±5° 0. ± .0 ±0.25 .00 ±0.20		 ATTEND TECHNOLOGY INC. www.attend.com.tw	
SCALE: AS SHOWN	UNIT: mm		
DRAWN Willis	2009/04/15	DRAWN NAME: Micro SD Socket Push-Pull Type	
CHECKED	/ /	PRODUCT NO. 112I-TXAR-R	
APPROVED	/ /	FILE NAME: 112I-TXAR-R_B_1	
REV.		SIZE A4	REV.

REV.	DESCRIPTION	DATE	SIZE	REV.
1			A4	